



## DMN2710UDWQ

#### **Product Summary**

BV <sub>DSS</sub>	RDS(ON) MAX	Id мах @Ta = +25°С
00)/	0.45Ω @ V <sub>GS</sub> = 4.5V	0.8A
20V	0.6Ω @ V <sub>GS</sub> = 2.5V	0.7A

## Description

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- Power Supply Converter Circuits

#### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

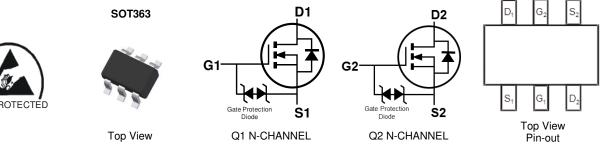
#### **Features and Benefits**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
  Ultra-Small Surface Mount Package
- Ultra-Small Surface Mount Packag
   D. Dustastast
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN2710UDWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

## **Mechanical Data**

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 3
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)



## Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2710UDWQ-7	SOT363	3,000/Tape & Reel
DMN2710UDWQ-13	SOT363	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**

	E	3D	1	Y	М	
	M <u>Y</u>		<u>.</u>	۱C	18	
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BD1 = Product Type Marking Code

YM = Date Code Marking

 $\overline{Y}$  = Year (ex: I = 2021)

M = Month (ex: 9 = September)

Date Code Key												
Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code		J	K	L	М	N	0	Р	R	S	Т	U
								-	_	_		_
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Character	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	20	V		
Gate-Source Voltage	Vgss	±6	V		
Continuous Drain Current (Note 6) $V_{GS}$ = 4.5V	ID	0.8 0.6	А		
Maximum Continuous Body Diode Forward Curre	ls	0.47	A		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	%)		I <sub>DM</sub>	4.8	A

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

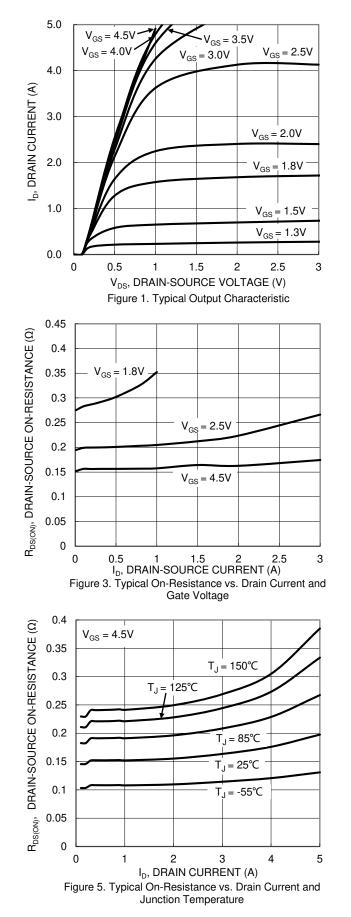
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	0.36	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	348	°C/W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	0.49	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	256	°C/W
Operating and Storage Temperature Range	·	TJ, TSTG	-55 to +150	°C

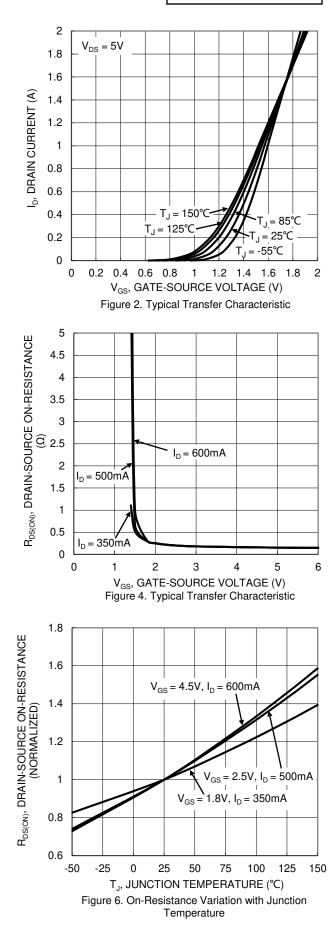
## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)				•	•		
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	20	—	_	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	@Tc = +25°C	IDSS	_	—	100	nA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage		IGSS	_		±1.0	μA	$V_{GS} = \pm 4.5 V$ , $V_{DS} = 0 V$
ON CHARACTERISTICS (Note 7)				•	•		
Gate Threshold Voltage		V <sub>GS(TH)</sub>	0.5	—	1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
				0.15	0.45		$V_{GS} = 4.5V, I_D = 600mA$
Static Drain-Source On-Resistance		RDS(ON)	_	0.19	0.6	Ω	$V_{GS} = 2.5V, I_{D} = 500mA$
				0.28	0.75	1	VGS = 1.8V, ID = 350mA
Diode Forward Voltage (Note 7)		VSD	_	0.7	1.2	V	VGS = 0V, IS = 150mA
DYNAMIC CHARACTERISTICS (Note 8)				•	•		
Input Capacitance		Ciss	_	42		pF	
Output Capacitance		Coss	_	13	—	pF	VDS = 16V, VGS = 0V f = 1.0MHz
Reverse Transfer Capacitance		Crss	_	6.5	—	pF	
Total Gate Charge		Qg	_	0.6	—	nC	
Gate-Source Charge		Qgs	_	0.1	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Drain Charge		Q <sub>gd</sub>	_	0.1	_	nC	- I <sub>D</sub> = 250mA
Turn-On Delay Time		tD(ON)	_	4.9	_	ns	
Turn-On Rise Time		tR	_	3.1	_	ns	$V_{DD} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time		tD(OFF)	_	386	—	ns	R <sub>L</sub> = 47Ω, R <sub>g</sub> = 10Ω I <sub>D</sub> = 200mA
Turn-Off Fall Time		t⊧	—	174	—	ns	
Reverse Recovery Time		trr	—	88	—	ns	I <sub>F</sub> = 1A, di/dt = 100A/µs
Reverse Recovery Charge		QRR	_	29		nC	

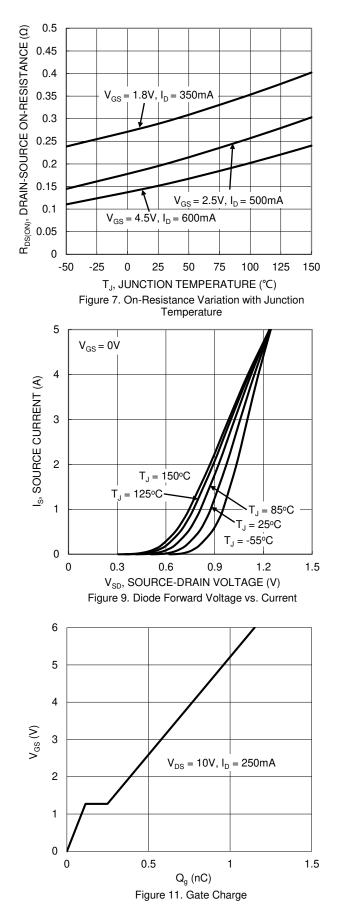
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing. Notes:

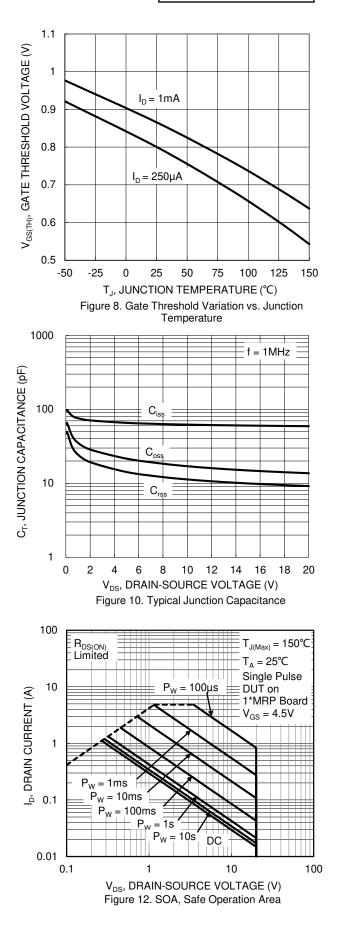






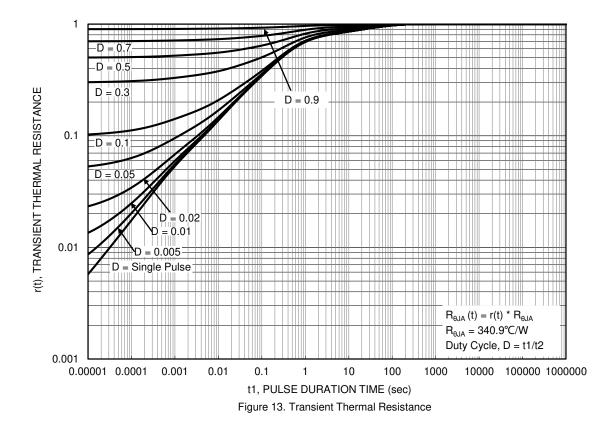






DMN2710UDWQ Document number: DS42959 Rev. 2 - 2

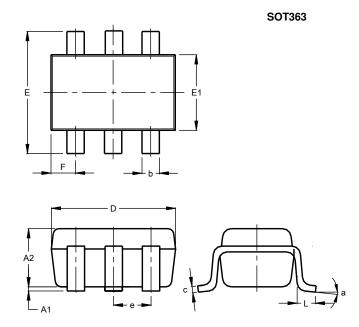






## **Package Outline Dimensions**

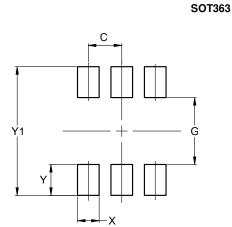
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SOT363								
Dim	Min	Max	Тур						
A1	0.00	0.10	0.05						
A2	0.90	1.00	0.95						
b	0.10	0.30	0.25						
C	0.10	0.22	0.11						
D	1.80	2.20	2.15						
Е	2.00	2.20	2.10						
E1	1.15	1.35	1.30						
е	C	).650 E	SC						
F	0.40	0.45	0.425						
L	0.25	0.40	0.30						
а	0°	8°							
All I	Dimen	sions	in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500



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